International IOR Rectifier

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Solder Plated for Reflowing

Description

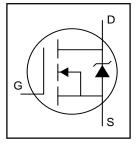
Third Generation HEXFET®s from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

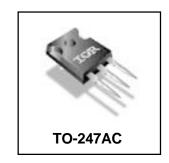
The solder plated version of the TO-247 allows the reflow soldering of the package heatsink to a substrate material.

IRFP460P

HEXFET® Power MOSFET



$V_{DSS} = 500V$						
$R_{DS(on)} = 0.27\Omega$						
$I_{D} = 20A$						



Absolute Maximum Ratings

	Parameter	Max.	Units	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	20		
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	13	A	
I _{DM}	Pulsed Drain Current ①	80		
P _D @T _C = 25°C	Power Dissipation	280	W	
	Linear Derating Factor	2.2	W/°C	
V _{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy ②	960	mJ	
I _{AR}	Avalanche Current ①	20	А	
E _{AR}	Repetitive Avalanche Energy ①	28	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	3.5	V/ns	
TJ	Operating Junction and	-55 to + 150		
T _{STG}	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting torque, 6-32 or M3 srew	10 lbf•in (1.1N•m)		
	Maximum Reflow Temperature	230 (Time above 183 °C		
		should not exceed 100s)	°C	

Thermal Resistance

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	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case		0.45	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24		°C/W
$R_{\theta JA}$	Junction-to-Ambient		40	

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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	500			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.63		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.27	Ω	V _{GS} = 10V, I _D = 12A ④
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
g _{fs}	Forward Transconductance	13			S	V _{DS} = 50V, I _D =12A
I _{DSS}	Drain-to-Source Leakage Current			25	μA	V _{DS} = 500V, V _{GS} = 0V
DSS	Brain to Oddroe Eddrage Garrent			250	μΛ	$V_{DS} = 400V, V_{GS} = 0V, T_{J} = 125$ °C
lass	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
I _{GSS}	Gate-to-Source Reverse Leakage			-100	''^	V _{GS} =-20V
Qg	Total Gate Charge			210		I _D = 20A
Q _{gs}	Gate-to-Source Charge			29	nC	$V_{DS} = 400V$
Q_{gd}	Gate-to-Drain ("Miller") Charge			110		V _{GS} = 10V, See Fig. 6 and 13 ④
t _{d(on)}	Turn-On Delay Time		18			V _{DD} = 250V
t _r	Rise Time		59		ns	$I_D = 20A$
t _{d(off)}	Turn-Off Delay Time		110		115	$R_G = 4.3\Omega$
t _f	Fall Time		58			$R_D = 13\Omega$, See Fig. 10 ④
L _D	Internal Drain Inductance		5.0			Between lead,
					nH	6mm (0.25in.)
L _S	Internal Source Inductance		13			from package and center of die contact
C _{iss}	Input Capacitance		4200			V _{GS} = 0V
Coss	Output Capacitance		870			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		350		pF	f = 1.0MHz, See Fig. 5

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions					
Is	Continuous Source Current		20	20	20	MOSFET symbol					
	(Body Diode)			A	showing the						
I _{SM}	Pulsed Source Current			90	90		90	90	80] ^`	integral reverse
	(Body Diode) ①		80		p-n junction diode.						
V_{SD}	Diode Forward Voltage			1.8	V	$T_J = 25^{\circ}C$, $I_S = 20A$, $V_{GS} = 0V$ 4					
t _{rr}	Reverse Recovery Time		570	860	ns	T _J = 25°C, I _F = 20A					
Q _{rr}	Reverse RecoverCharge		5.7	8.6	μC	di/dt = 100A/µs ④					
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L _S +L _D)									

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\label{eq:starting} \begin{array}{ll} \text{ Starting T}_J = 25^{\circ}\text{C}, \ L = & 4.8\text{mH} \\ \text{R}_G = 25\Omega, \ I_{AS} = 20\text{A}. \ \text{(See Figure 12)} \end{array}$
- $\label{eq:loss} \begin{array}{l} \text{ } 3 \text{ } I_{SD} \leq 20A, \text{ } di/dt \leq 160A/\mu s, \text{ } V_{DD} \leq V_{(BR)DSS}, \\ T_{J} \leq 150^{\circ}C \end{array}$
- 4 Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$.

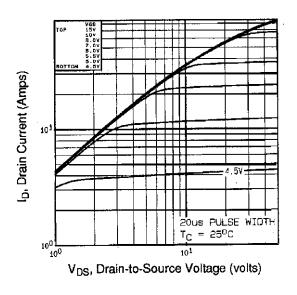


Fig 1. Typical Output Characteristics

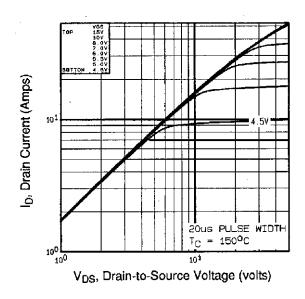


Fig 2. Typical Output Characteristics

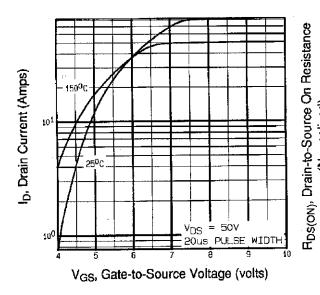


Fig 3. Typical Transfer Characteristics

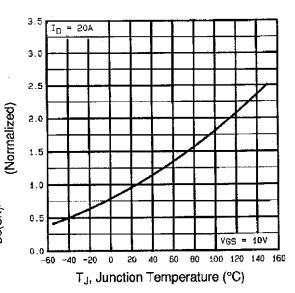


Fig 4. Normalized On-Resistance Vs. Temperature

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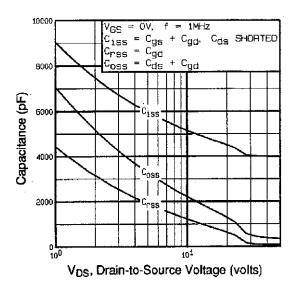


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

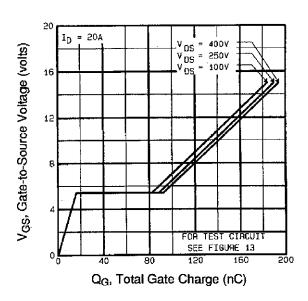


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

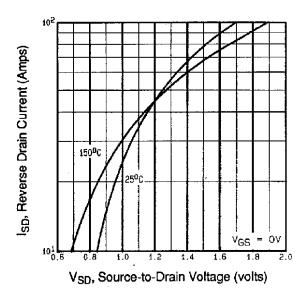


Fig 7. Typical Source-Drain Diode Forward Voltage

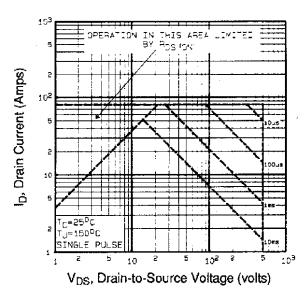


Fig 8. Maximum Safe Operating Area

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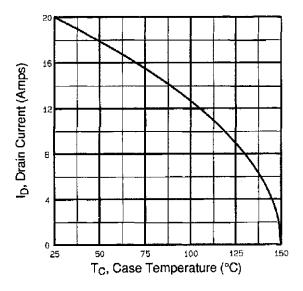


Fig 9. Maximum Drain Current Vs. Case Temperature

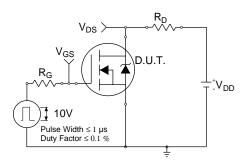


Fig 10a. Switching Time Test Circuit

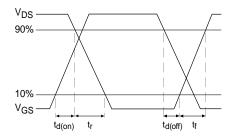


Fig 10b. Switching Time Waveforms

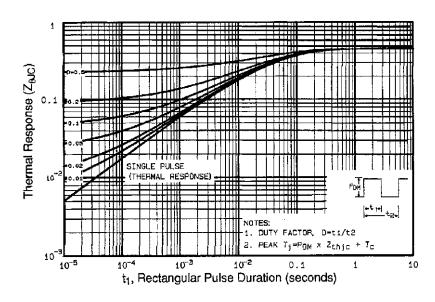


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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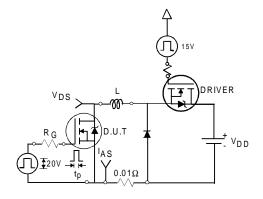


Fig 12a. Unclamped Inductive Test Circuit

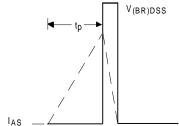
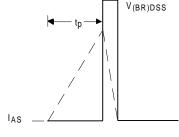


Fig 12b. Unclamped Inductive Waveforms



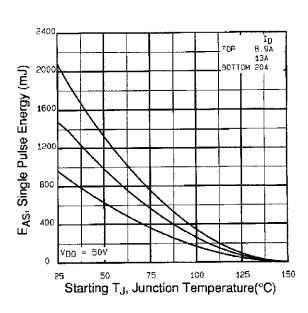


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

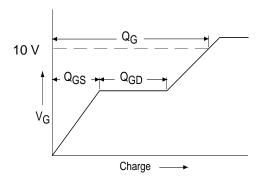


Fig 13a. Basic Gate Charge Waveform

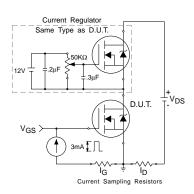
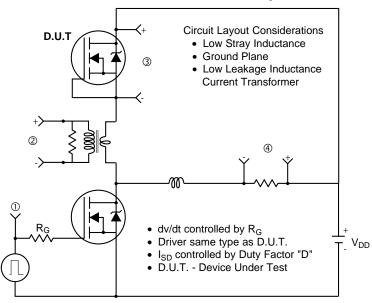


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



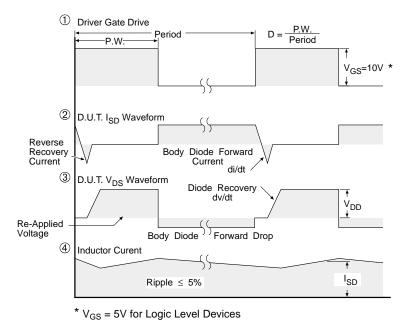


Fig 14. For N-Channel HEXFET®s

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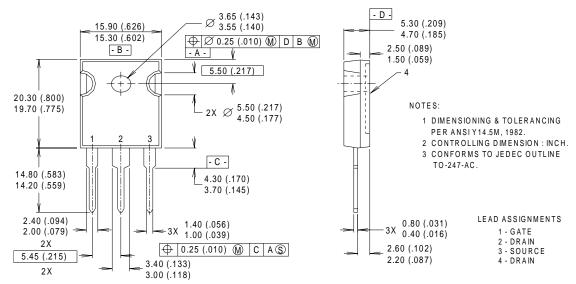
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Package Outline

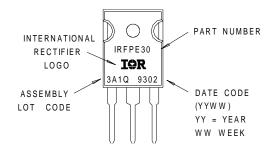
TO-247AC

Dimensions are shown in millimeters (inches)



Part Marking Information **TO-247AC**

EXAMPLE: THIS IS AN IRFPE30 WITH ASSEMBLY LOT CODE 3A1Q



Data and specifications subject to change without notice. This product has been designed and qualified for the industrial market.

Qualification Standards can be found on IR's Web site.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

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